

MAC97A8; **MAC97A6**

Logic level triac

Rev. 01 — 29 March 2001

Product specification

1. Description

Logic level sensitive gate triac intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

Product availability:

MAC97A8 in SOT54 (TO-92)

MAC97A6 in SOT54 (TO-92) available on request - contact your sales representative.

2. Features

- Blocking voltage to 600 V (MAC97A8)
- RMS on-state current to 0.6 A
- Sensitive gate in all four quadrants
- Low cost package.

3. Applications

- General purpose bidirectional switching
- Phase control applications
- Solid state relays.

4. Pinning information

Table 1: Pinning - SOT54 (TO-92), simplified outline and symbol

Pin	Description	Simplified outline	Symbol
1	main terminal 2	4	1
2	gate	2,3	■
3	main terminal 1	MSB	= 2 = 3 MBL305 0:
		SOT54 (TO-92)	





5. Quick reference data

Table 2: Quick reference data

Symbol	Parameter	Conditions	Тур	Max	Unit
V_{DRM}	repetitive peak off-state voltage				
	MAC97A8	T _j = 25 to 125 °C	_	600	V
	MAC97A6	T _j = 25 to 125 °C	_	400	V
I _{T(RMS)}	on-state current (RMS value)	full sine wave; T _{lead} ≤ 50 °C; Figure 5	_	0.6	Α
I _{TSM}	non-repetitive peak on-state current		_	8.0	Α

6. Limiting values

Table 3: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DRM}	repetitive peak off-state voltage				
	MAC97A8	$T_j = 25 \text{ to } 125 ^{\circ}\text{C}$	_	600	V
	MAC97A6	$T_j = 25 \text{ to } 125 ^{\circ}\text{C}$	_	400	V
I _{T(RMS)}	on-state current (RMS value)	full sine wave; T _{lead} ≤ 50 °C; Figure 5	_	0.6	Α
I _{TSM}	non-repetitive peak on-state current	full sine wave; T _j = 25 °C prior to surge			
		t = 20 ms	_	8.0	Α
		t = 16.7 ms	_	8.8	Α
l ² t	I ² t for fusing	t = 10 ms	_	0.32	A ² s
dl _T /dt	repetitive rate of rise of on-state current after triggering	I_{TM} = 1.0 A; I_G = 0.2 A; dI_G/dt = 0.2 A/ μs			
		T2+ G+	_	50	A/μs
		T2+ G-	_	50	A/μs
		T2- G-	_	50	A/μs
		T2- G+	_	10	A/μs
I _{GM}	gate current (peak value)	t = 2 μs max	_	1	Α
V_{GM}	gate voltage (peak value)	t = 2 μs max		5	V
P_{GM}	gate power (peak value)	t = 2 μs max	_	5	W
$P_{G(AV)}$	average gate power	$T_{case} = 80 ^{\circ}C; t = 2 \mu s max$	_	0.1	W
T _{stg}	storage temperature		-40	+150	°C
Tj	operating junction temperature		-40	+125	°C

7. Thermal characteristics

Table 4: Thermal characteristics

Symbol	Parameter	Conditions	Value	Unit
R _{th(j-lead)}	_(j-lead) thermal resistance from junction to lead full cycle		60	K/W
		half cycle	80	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	mounted on a printed circuit board; lead length = 4 mm; Figure 1	150	K/W

7.1 Transient thermal impedance

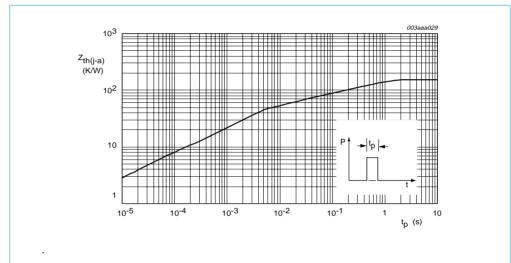


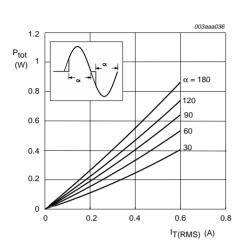
Fig 1. Transient thermal impedance from junction to ambient as a function of pulse duration.

8. Characteristics

Table 5: Characteristics

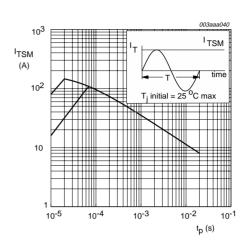
 $T_i = 25 \,^{\circ}C$ unless otherwise specified

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
I _{GT}	gate trigger current	$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; } Figure 8$				
		T2+ G+	_	1	5	mA
		T2+ G-	_	2	5	mA
		T2- G-	_	2	5	mA
		T2- G+	_	4	7	mA
IL	latching current	$V_D = 12 \text{ V; } I_{GT} = 0.1 \text{ A; } Figure 9$				
		T2+ G+	_	1	10	mA
		T2+ G-	_	5	10	mA
		T2- G-	_	1	10	mA
		T2- G+	_	2	10	mA
I _H	holding current	$V_D = 12 \text{ V; } I_{GT} = 0.1 \text{ A; } Figure 10$	_	1	10	mA
V _T	on-state voltage	I _T = 0.85 A; Figure 11	_	1.4	1.9	V
V_{GT}	gate trigger voltage	$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; } Figure 7$	_	0.9	2	V
		$V_D = V_{DRM}; I_T = 0.1 A; T_j = 110 ^{\circ}C$	0.1	0.7	_	V
I _D	off-state leakage current	$V_D = V_{DRM (max)}; T_j = 110 ^{\circ}C$	_	3	100	μΑ
Dynamic	characteristics					
dV _D /dt	critical rate of rise of off-state voltage	$V_D = 67\%$ of $V_{DM(max)}$; $T_{case} = 110$ °C; exponential waveform; gate open circuit; Figure 12	30	45	-	V/μs
dV _{com} /dt	critical rate of rise of commutation voltage	V_D = rated V_{DRM} ; T_{case} = 50 °C; I_{TM} = 0.84 A; commutating dl/dt = 0.3 A/ms	_	5	-	V/μs
t _{gt}	gate controlled turn-on time	$I_{TM} = 1.0 \text{ A}; V_D = V_{DRM(max)};$ $I_G = 25 \text{ mA}; dI_G/dt = 5 \text{ A}/\mu\text{s}$	-	2	-	μs



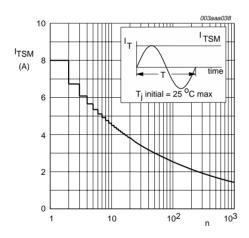
 α = conduction angle

Fig 2. Maximum on-state dissipation as a function of RMS on-state current; typical values.



 $t_p \le 20 \text{ ms}$

Fig 3. Maximum permissible non-repetitive peak on-state current as a function of pulse width for sinusoidal currents; typical values.



n = number of cycles at f = 50 Hz

Fig 4. Maximum permissible non-repetitive peak on-state current as a function of number of cycles for sinusoidal currents; typical values.

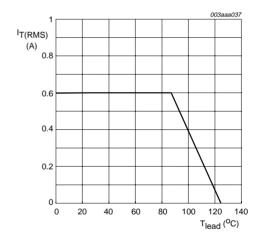
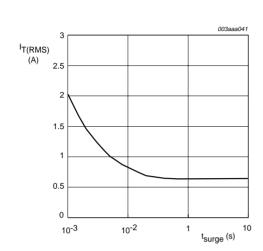
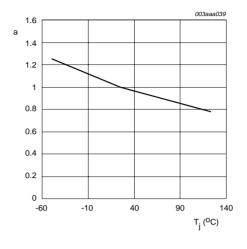


Fig 5. Maximum permissible RMS current as a function of lead temperature; typical values.



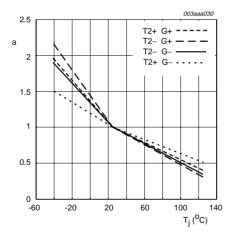
f = 50 Hz; T_{lead} ≤ 50 °C

Fig 6. Maximum permissible repetitive RMS on-state current as a function of surge duration for sinusoidal currents; typical values.



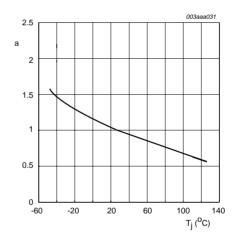
 $a = \frac{V_{GT(Tj)}}{V_{GT(25^{\circ}C)}}$

Fig 7. Normalized gate trigger voltage as a function of junction temperature; typical values.



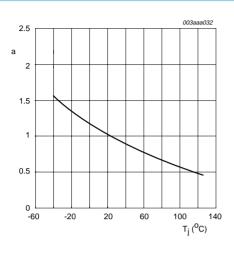
 $a = \frac{I_{GT(Tj)}}{I_{GT(25^{\circ}C)}}$

Fig 8. Normalized gate trigger current as a function of junction temperature; typical values.



 $a = \frac{I_{L(Tj)}}{I_{L(25^{\circ}C)}}$

Fig 9. Normalized latching current as a function of junction temperature; typical values.



 $a = \frac{I_{H(Tj)}}{I_{H(25^{\circ}C)}}$

Fig 10. Normalized holding current as a function of junction temperature; typical values.

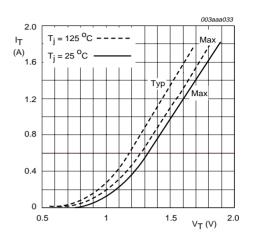


Fig 11. On-state current as a function of on-state voltage; typical and maximum values.

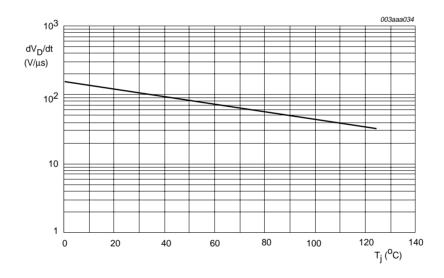


Fig 12. Critical rate of rise of off-state voltage as a function of junction temperature; typical values.

9. Package outline

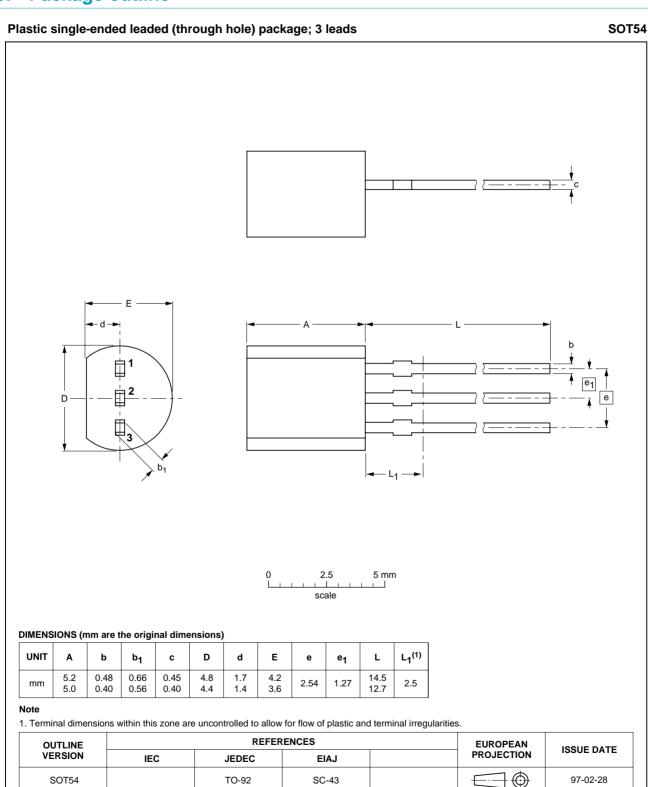


Fig 13. SOT54 (TO-92).

10. Revision history

Table 6: Revision history

Rev	Date	CPCN	Description
01	20010329	-	Product specification; initial version

11. Data sheet status

Data sheet status [1]	Product status [2]	Definition
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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